

MOSFET

OptiMOS[™] 5 Power-Transistor, 25 V

Features

- Very low on-resistance R_{DS(on)}
 100% avalanche tested
 Superior thermal resistance

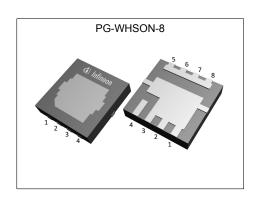
- N-channel, logic level
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V _{DS}	25	V
R _{DS(on),max}	0.58	mΩ
I _D	310	A
Qoss	41	nC
Q _G (0V4.5V)	29	nC











Type / Ordering Code	Package	Marking	Related Links
IQE006NE2LM5SC	PG-WHSON-8	Α	-

OptiMOS[™] 5 Power-Transistor, 25 V IQE006NE2LM5SC



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OptiMOS[™] 5 Power-Transistor, 25 V IQE006NE2LM5SC



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Sumb al		Value	s		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - - -	- - -	310 196 173 47	A	V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C V _{GS} =4.5 V, T _C =100 °C V _{GS} =10 V, T _A =25 °C, R _{thA} =60 °C/W ²)
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1240	Α	<i>T</i> _A =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	140	mJ	I_D =20 A, R_{GS} =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	-	89 2.1	W	T _C =25 °C T _A =25 °C, R _{thJA} =60 °C/W ²⁾
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1 55/150/56

2 Thermal characteristics

Table 3 **Thermal characteristics**

Dorometer	Cumbal	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	-	-	1.4	°C/W	-
Thermal resistance, junction - case, top	R _{thJC}	-	0.7	-	°C/W	-
Device on PCB, 6 cm² cooling area²)	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Damain Adam	O a a a b		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	25	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.2	1.6	2.0	V	V _{DS} =V _{GS} , I _D =250 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1.0 100	μΑ	V _{DS} =20 V, V _{GS} =0 V, T _j =25 °C V _{DS} =20 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =16 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.49 0.64	0.58 0.75	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =20 A
Gate resistance ¹⁾	R _G	-	0.8	1.2	Ω	-
Transconductance	g fs	-	260	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 30 A$

Table 5 Dynamic characteristics

Doromotor	Complete	Values			11	Nata / Tant Candition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	4100	5453	pF	V _{GS} =0 V, V _{DS} =12 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	1700	2261	pF	V _{GS} =0 V, V _{DS} =12 V, f=1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	130	195	pF	V _{GS} =0 V, V _{DS} =12 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	5.3	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	2.6	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{\sf d(off)}$	-	27.0	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	5.3	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Parameter	Cumbal	Values			11	Nata / Tank Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	9.2	-	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	-	6.6	-	nC	V _{DD} =12 V, I _D =20 A, V _{GS} =0 to 4.5 V
Gate to drain charge ¹⁾	Q _{gd}	-	5.6	8.4	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	8.2	-	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	29	36	nC	$V_{\rm DD}$ =12 V, $I_{\rm D}$ =20 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.2	-	V	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	62	82	nC	V _{DD} =12 V, I _D =20 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	60	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	41	55	nC	V _{DS} =12 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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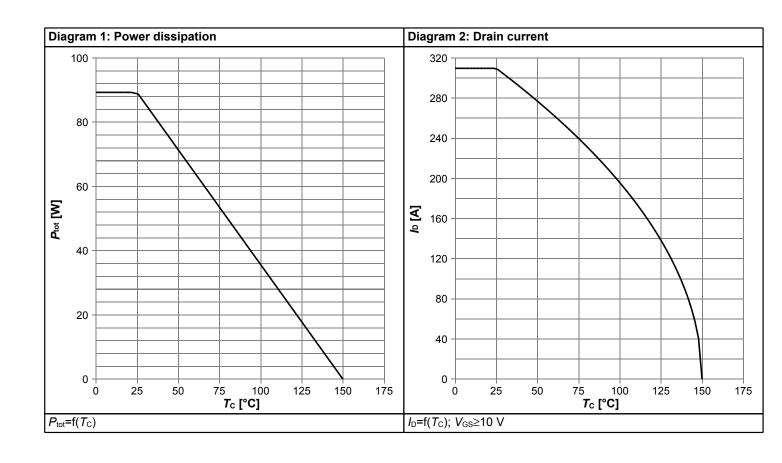


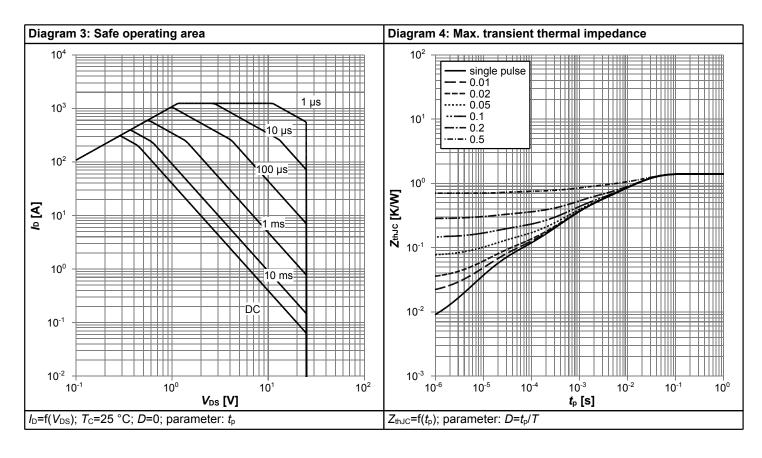
Table 7 Reverse diode

Danier of an	Cumbal		Values			Nata / Tank Can diking	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	83	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	1240	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.75	1.0	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C	
Reverse recovery charge	Qrr	-	25	_	nC	V_R =12 V, I_F =20 A, di_F/dt =100 A/ μ s	

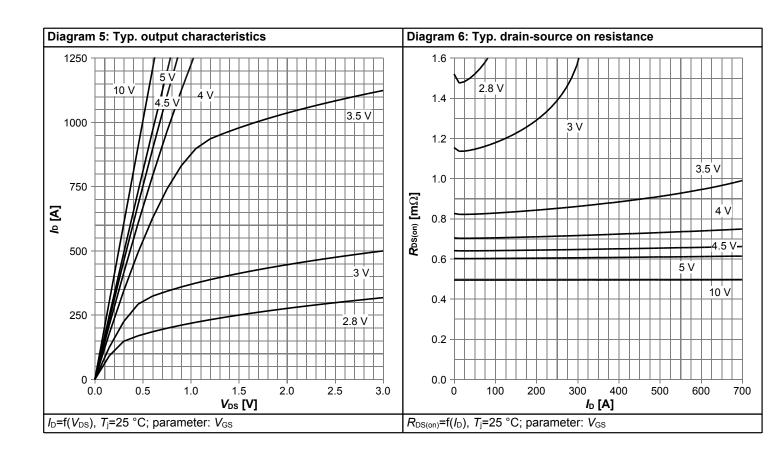


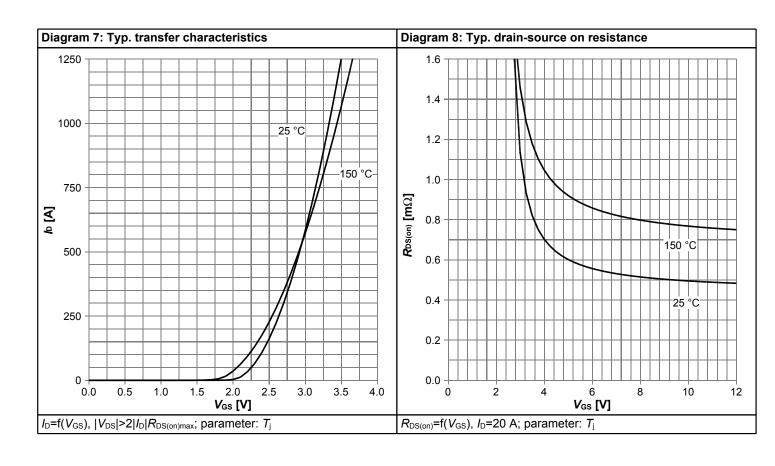
4 Electrical characteristics diagrams



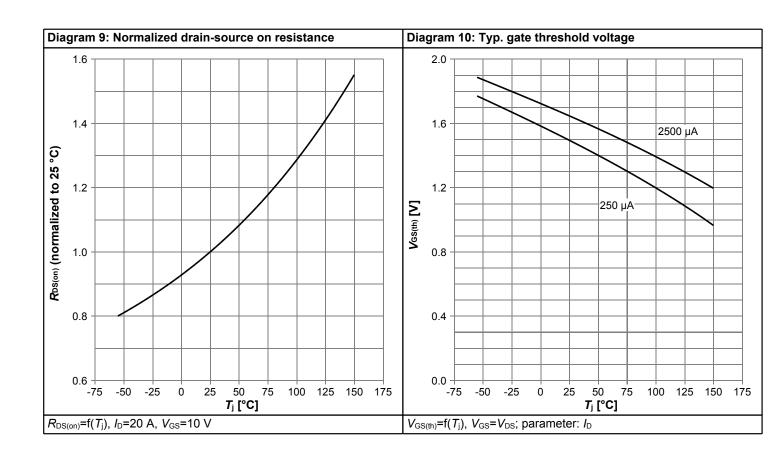


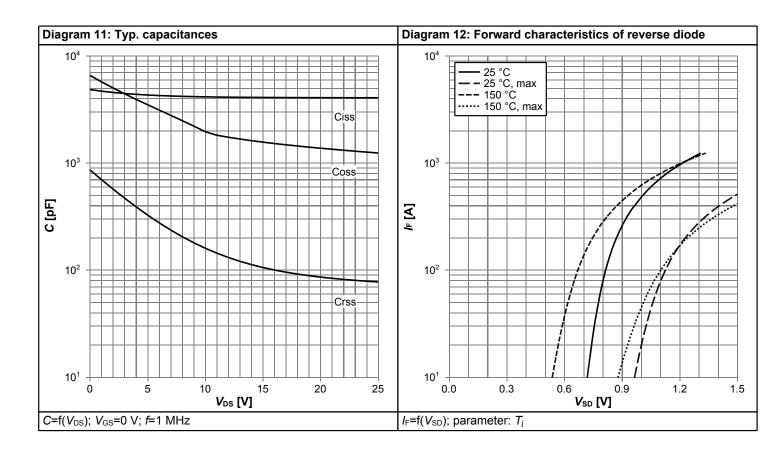




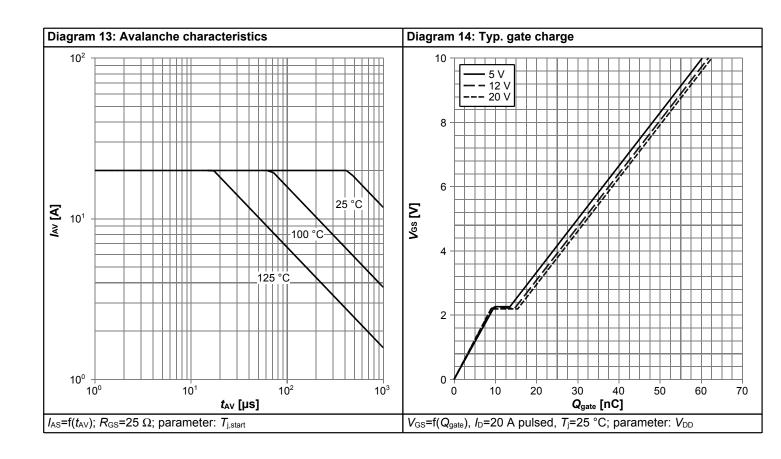


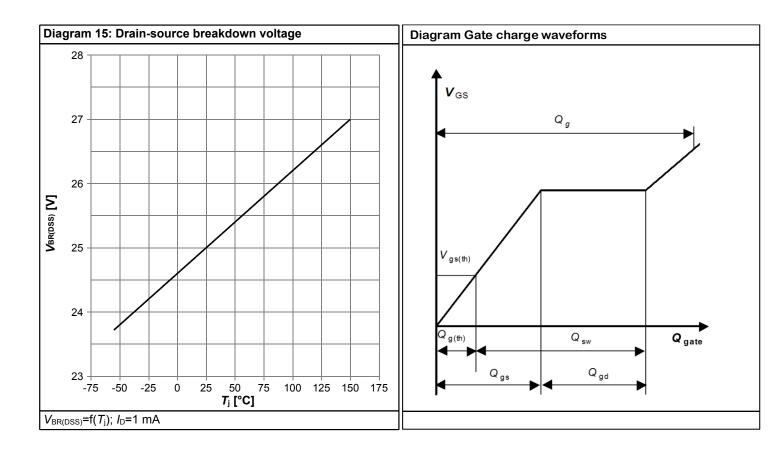






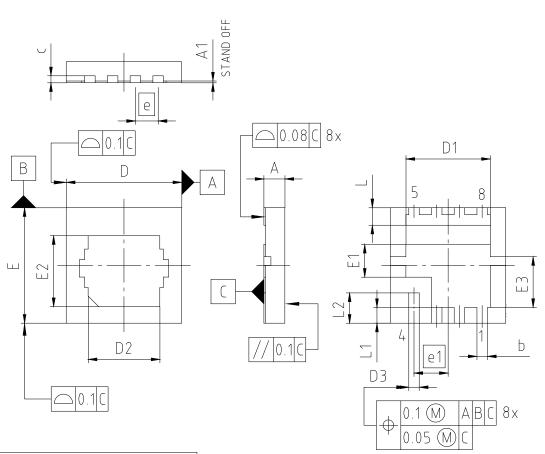








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-WHS	PG-WHSON-8-U01					
DIMENSIONS	MILLIMETERS						
DIMENSIONS	MIN.	MAX.					
Α		0.75					
A1	0	0.05					
b	0.20	0.40					
С	0.10	0.30					
D	3.20	3.40					
D1	2.31	2.51					
D2	1.95	2.25					
D3	0.20	0.40					
E	3.20	3.40					
E1	0.84	1.04					
E2	1.93	2.23					
E3	1.35	1.55					
е	0.	65					
e1	0.975						
L	0.40	0.60					
L1	0.35	0.55					
L2	0.77	0.97					

Figure 1 Outline PG-WHSON-8, dimensions in mm



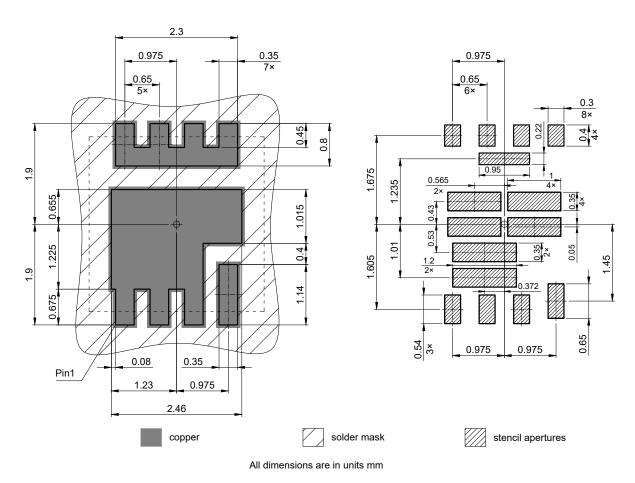


Figure 2 Outline Footprint (PG-WHSON-8-1), dimensions in mm



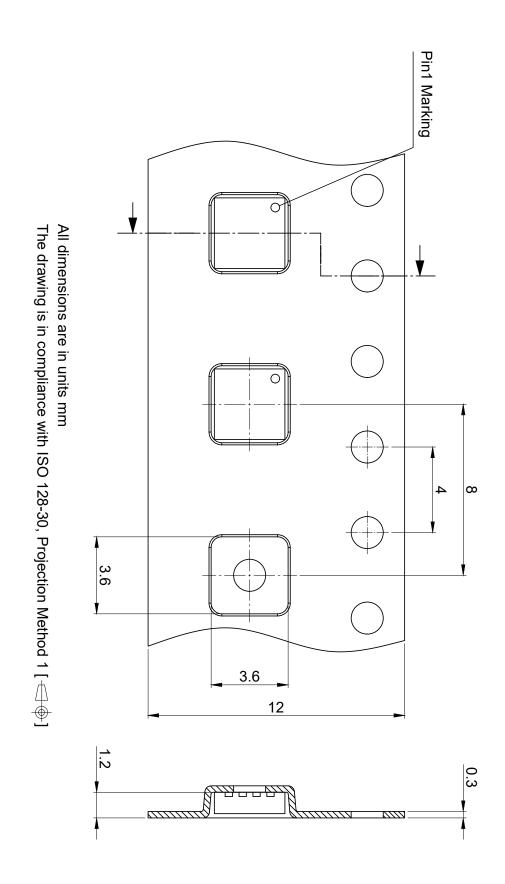


Figure 3 Outline Tape (PG-WHSON-8-1), dimensions in mm

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Revision History

IQE006NE2LM5SC

Revision: 2022-04-28, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2022-04-28	Release of final version

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